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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M4F
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, CSIO, EBI/EMI, I ² C, LINbus, SD, SPI, UART/USART
Peripherals	DMA, I ² S, LVD, POR, PWM, WDT
Number of I/O	152
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 32x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/s6e2c48j0agv2000a

Multi-function Timer (Max three Units)

The multi-function timer is composed of the following blocks:

Minimum resolution: 5.00 ns

- 16-bit free-run timer × 3 ch/unit
- Input capture × 4 ch/unit
- Output compare × 6 ch/unit
- A/D activation compare × 6 ch/unit
- Waveform generator × 3 ch/unit
- 16-bit PPG timer × 3 ch/unit

The following functions can be used to achieve the motor control:

- PWM signal output function
- DC chopper waveform output function
- Dead time function
- Input capture function
- A/D convertor activate function
- DTIF (motor emergency stop) interrupt function

Real-Time Clock (RTC)

The real-time clock can count year, month, day, hour, minute, second, or day of the week from 00 to 99.

- Interrupt function with specifying date and time (year/month/day/hour/minute) is available. This function is also available by specifying only year, month, day, hour, or minute.
- Timer interrupt function after set time or each set time.
- Capable of rewriting the time with continuing the time count.
- Leap year automatic count is available.
-

Quadrature Position/Revolution Counter (QPRC; Max four Channels)

The Quadrature Position/Revolution Counter (QPRC) is used to measure the position of the position encoder. It is also possible to use up/down counter.

- The detection edge of the three external event input pins AIN, BIN and ZIN is configurable.
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers

Dual Timer (32-/16-bit Down Counter)

The dual timer consists of two programmable 32/16-bit down counters.

Operation mode is selectable from the following for each channel:

- Free-running
- Periodic (= Reload)
- One shot

Watch Counter

The watch counter is used for wake up from low-power consumption mode. It is possible to select the main clock, sub clock, built-in High-speed CR clock, or built-in low-speed CR clock as the clock source.

- Interval timer: up to 64 s (max) with a sub clock of 32.768 kHz

External Interrupt Controller Unit

- External interrupt input pin: Max 32 pins
- Include one non-maskable interrupt (NMI)

Watchdog Timer (2 Channels)

A watchdog timer can generate interrupts or a reset when a time-out value is reached.

This series consists of two different watchdogs: a "hardware" watchdog and a "software" watchdog.

The hardware watchdog timer is clocked by low-speed internal CR oscillator. The hardware watchdog is thus active in any power saving mode except RTC mode and Stop mode.

Cyclic Redundancy Check (CRC) Accelerator

The CRC accelerator helps to verify data transmission or storage integrity.

CCITT CRC16 and IEEE-802.3 CRC32 are supported.

- CCITT CRC16 generator polynomial: 0x1021
- IEEE-802.3 CRC32 generator polynomial: 0x04C11DB7

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
8	8	8	D3	PA6	E	I
				SOT1_0 (SDA1_0))		
				DTT12X_0		
				MADATA06_0		
9	9	9	D4	PA7	E	I
				SCK1_0 (SCL1_0)		
				IC20_0		
				MADATA07_0		
10	10	-	E2	P50	E	I
				SCS72_0		
				RTO00_1 (PPG00_1)		
				TIOA8_2		
				MADATA16_0		
11	11	-	E3	P51	E	I
				SCS73_0		
				RTO01_1 (PPG00_1)		
				TIOB8_2		
				MADATA17_0		
12	12	-	E4	P52	E	I
				RTO02_1 (PPG02_1)		
				TIOA9_2		
				MADATA18_0		
13	-	-	-	P53	E	I
				RTO03_1 (PPG02_1)		
				TIOB9_2		
				MADATA19_0		
14	13	10	E5	PA8	I	Q
				SIN7_0		
				IC21_0		
				INT02_0		
				WKUP1		
15	14	11	F1	MADATA08_0	N	I
				PA9		
				SOT7_0 (SDA7_0)		
				IC22_0		
16	15	12	F2	MADATA09_0	N	I
				PAA		
				SCK7_0 (SCL7_0)		
				IC23_0		
				MADATA10_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
51	41	-	L2	P5D	E	K
				SIN10_1		
				TIOB11_2		
				INT01_2		
				MADATA29_0		
				I2SMCLK0_0		
52	42	-	L3	P5E	E	I
				SOT10_1 (SDA10_1)		
				TIOA12_2		
				MADATA30_0		
				I2SDO0_0		
53	43	-	M2	P5F	E	I
				SCK10_1 (SCL10_1)		
				TIOB12_2		
				MADATA31_0		
				I2SWS0_0		
54	44	36	M1	VSS	-	-
55	45	37	N1	VCC	-	-
56	46	38	N2	P40	G	K
				SIN3_1		
				RTO10_0 (PPG10_0)		
				TIOA0_0		
				AIN0_0		
				INT23_0		
				MCSX7_0		
57	47	39	N3	P41	G	I
				SOT3_1 (SDA3_1)		
				RTO11_0 (PPG10_0)		
				TIOA1_0		
				BIN0_0		
				MCSX6_0		
58	48	40	M3	P42	G	I
				SCK3_1 (SCL3_1)		
				RTO12_0 (PPG12_0)		
				TIOA2_0		
				ZIN0_0		
				MCSX5_0		
59	49	41	L4	P43	G	K
				SIN15_0		
				RTO13_0 (PPG12_0)		
				TIOA3_0		
				INT04_0		
				MCSX4_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
180	148	118	E9	PC3	K	I
				TIOB7_0		
181	149	119	F9	PC4	K	I
				TIOA7_0		
182	150	120	C8	PC5	K	I
				TIOB14_0		
183	151	121	D8	PC6	K	I
				TIOA14_0		
184	152	122	E8	PC7	E	K
				INT13_0		
				CROUT_1		
185	153	123	A10	PC8	K	I
186	154	124	F8	PC9	K	I
				TIOB15_0		
187	155	125	B7	PCA	K	I
				TIOA15_0		
188	156	126	A9	VCC	-	-
189	157	127	A8	VSS	-	-
190	158	128	A7	PCB	L	K
				INT28_0		
191	159	129	C7	PCC	K	I
192	160	130	A6	PCD	L	K
				SOT4_1 (SDA4_1)		
				INT14_0		
193	161	131	D7	PCE	L	K
				SIN4_1		
				INT15_0		
194	162	132	E7	PCF	L	K
				RTS4_1		
				INT12_0		
195	163	133	F7	PD0	L	K
				INT30_1		
196	164	134	B6	PD1	L	K
				INT31_1		
197	165	135	C6	PD2	L	I
				CTS4_1		
				FRCK2_1		
198	166	136	D6	P6E	E	K
				ADTG_5		
				SCK4_1 (SCL4_1)		
				IC23_1		
				INT29_0		
199	-	-	-	P6D	E	I
				SCK14_1 (SCL14_1)		
				IC22_1		
				TIOB6_2		

Signal Descriptions

The number after the underscore (" _") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel.

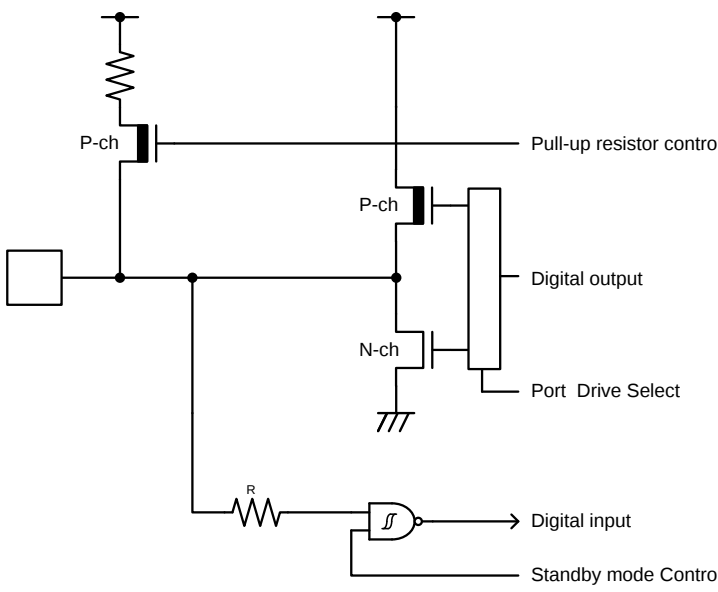
Use the extended port function register (EPFR) to select the pin.

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
ADC	ADTG_0	A/D converter external trigger input pin	24	19	16	F6
	ADTG_1		32	23	20	G5
	ADTG_2		44	34	29	J3
	ADTG_3		209	169	137	C5
	ADTG_4		157	127	103	D13
	ADTG_5		198	166	136	D6
	ADTG_6		119	-	-	-
	ADTG_7		71	56	48	M5
	ADTG_8		80	65	55	L6
	AN00	A/D converter analog input pin. ANxx describes ADC ch.xx.	114	94	78	L11
	AN01		115	95	79	K13
	AN02		116	96	80	K12
	AN03		117	97	81	K14
	AN04		118	98	82	K11
	AN05		123	99	83	J13
	AN06		124	100	84	J12
	AN07		125	101	85	J11
	AN08		130	106	86	H9
	AN09		131	107	87	H12
	AN10		132	108	88	H14
	AN11		133	109	89	G14
	AN12		134	110	90	H13
	AN13		135	111	91	H11
	AN14		142	116	92	G10
	AN15		143	117	93	G9
	AN16		126	102	-	J10
	AN17		127	103	-	J9
	AN18		128	104	-	H10
	AN19		129	105	-	J14
	AN20		138	112	-	G13
	AN21		139	113	-	F14
	AN22		140	114	-	G12
	AN23		141	115	-	G11
	AN24		144	118	94	F10
	AN25		145	119	95	F11
	AN26		146	120	96	F12
	AN27		147	121	97	F13
	AN28		153	123	99	E11
	AN29		154	124	100	E12
	AN30		155	125	101	E13
	AN31		156	126	102	D12

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
Base Timer 0	TIOA0_0	Base Timer ch.0 TIOA Pin	56	46	38	N2
	TIOA0_1		45	35	30	J2
	TIOA0_2		114	94	78	L11
	TIOB0_0	Base Timer ch.0 TIOB Pin	82	67	57	L8
	TIOB0_1		21	-	-	-
	TIOB0_2		115	95	79	K13
Base Timer 1	TIOA1_0	Base Timer ch.1 TIOA Pin	57	47	39	N3
	TIOA1_1		46	36	31	K1
	TIOA1_2		116	96	80	K12
	TIOB1_0	Base Timer ch.1 TIOB Pin	83	68	58	K8
	TIOB1_1		22	-	-	-
	TIOB1_2		123	99	83	J13
Base Timer 2	TIOA2_0	Base Timer ch.2 TIOA Pin	58	48	40	M3
	TIOA2_1		47	37	32	K2
	TIOA2_2		124	100	84	J12
	TIOB2_0	Base Timer ch.2 TIOB Pin	84	69	59	J8
	TIOB2_1		26	-	-	-
	TIOB2_2		125	101	85	J11
Base Timer 3	TIOA3_0	Base Timer ch.3 TIOA Pin	59	49	41	L4
	TIOA3_1		48	38	33	K3
	TIOA3_2		130	106	86	H9
	TIOB3_0	Base Timer ch.3 TIOB Pin	91	76	60	K9
	TIOB3_1		27	-	-	-
	TIOB3_2		131	107	87	H12
Base Timer 4	TIOA4_0	Base Timer ch.4 TIOA Pin	60	50	42	M4
	TIOA4_1		49	39	34	K4
	TIOA4_2		132	108	88	H14
	TIOB4_0	Base Timer ch.4 TIOB Pin	92	77	61	P10
	TIOB4_1		28	-	-	-
	TIOB4_2		133	109	89	G14
Base Timer 5	TIOA5_0	Base Timer ch.5 TIOA Pin	61	51	43	N4
	TIOA5_1		50	40	35	L1
	TIOA5_2		134	110	90	H13
	TIOB5_0	Base Timer ch.5 TIOB Pin	93	78	62	N10
	TIOB5_1		29	-	-	-
	TIOB5_2		135	111	91	H11
Base Timer 6	TIOA6_0	Base Timer ch.6 TIOA Pin	179	147	117	D9
	TIOA6_1		85	70	-	N8
	TIOA6_2		200	-	-	-
	TIOB6_0	Base Timer ch.6 TIOB Pin	178	146	116	B8
	TIOB6_1		86	71	-	M8
	TIOB6_2		199	-	-	-

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
External Bus	MADATA00_0	External bus interface data bus (Address / data multiplex bus)	2	2	2	B2
	MADATA01_0		3	3	3	C2
	MADATA02_0		4	4	4	C3
	MADATA03_0		5	5	5	D5
	MADATA04_0		6	6	6	D2
	MADATA05_0		7	7	7	D1
	MADATA06_0		8	8	8	D3
	MADATA07_0		9	9	9	D4
	MADATA08_0		14	13	10	E5
	MADATA09_0		15	14	11	F1
	MADATA10_0		16	15	12	F2
	MADATA11_0		17	16	13	F3
	MADATA12_0		18	17	14	F4
	MADATA13_0		23	18	15	F5
	MADATA14_0		24	19	16	F6
	MADATA15_0		25	20	17	G2
	MADATA16_0		10	-	-	-
	MADATA17_0		11	-	-	-
	MADATA18_0		12	-	-	-
	MADATA19_0		13	-	-	-
	MADATA20_0		19	-	-	-
	MADATA21_0		20	-	-	-
	MADATA22_0		21	-	-	-
	MADATA23_0		22	-	-	-
	MADATA24_0		26	-	-	-
	MADATA25_0		27	-	-	-
	MADATA26_0		28	-	-	-
	MADATA27_0		29	-	-	-
	MADATA28_0		33	-	-	-
	MADATA29_0		51	-	-	-
	MADATA30_0		52	-	-	-
	MADATA31_0		53	-	-	-
	MDQM0_0	External bus interface byte mask signal output pin	30	21	18	G3
	MDQM1_0		31	22	19	G4
	MDQM2_0		34	-	-	-
	MDQM3_0		35	-	-	-
	MALE_0	External bus interface Address Latch enable output signal for multiplex	211	171	139	C4
	MRDY_0	External bus interface external RDY input signal	80	65	55	L6
	MCLKOUT_0	External bus clock signal	32	23	20	G5

Module	Pin name	Function	Pin No			
			LQQ 216	LQP 176	LQS 144	LBE 192
GPIO	PA0	General-purpose I/O port A	2	2	2	B2
	PA1		3	3	3	C2
	PA2		4	4	4	C3
	PA3		5	5	5	D5
	PA4		6	6	6	D2
	PA5		7	7	7	D1
	PA6		8	8	8	D3
	PA7		9	9	9	D4
	PA8		14	13	10	E5
	PA9		15	14	11	F1
	PAA		16	15	12	F2
	PAB		17	16	13	F3
	PAC		18	17	14	F4
	PAD		23	18	15	F5
	PAE		24	19	16	F6
	PAF		25	20	17	G2
	PB0	General-purpose I/O port B	126	102	-	J10
	PB1		127	103	-	J9
	PB2		128	104	-	H10
	PB3		129	105	-	J14
	PB4		138	112	-	G13
	PB5		139	113	-	F14
	PB6		140	114	-	G12
	PB7		141	115	-	G11
	PB8		119	-	-	-
	PB9		120	-	-	-
	PBA		121	-	-	-
	PBB		122	-	-	-
	PBC		148	-	-	-
	PBD		149	-	-	-
	PBE		150	-	-	-
	PBF		151	-	-	-

Type	Circuit	Remarks
S		• CMOS level output • (It is possible to select by port drive capability. Select register [PDSR]) • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -10 \text{ mA}$, $I_{OL} = 10 \text{ mA}$ (PDSR = 1) • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ (PDSR = 0) • When this pin is used as an I²C pin, the digital output P-ch transistor is always off.

6.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

1. Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

2. Discharge of static electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

3. Corrosive gases, dust, or oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

4. Radiation, including cosmic radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

5. Smoke, flame

CAUTION: Plastic molded devices are flammable and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

Peripheral Address Map

Start Address	End Address	Bus	Peripherals
0x4000_0000	0x4000_0FFF	AHB	MainFlash I/F register
0x4000_1000	0x4000_FFFF		Reserved
0x4001_0000	0x4001_0FFF	APB0	Clock/reset control
0x4001_1000	0x4001_1FFF		Hardware watchdog timer
0x4001_2000	0x4001_2FFF		Software watchdog timer
0x4001_3000	0x4001_4FFF		Reserved
0x4001_5000	0x4001_5FFF		Dual-timer
0x4001_6000	0x4001_FFFF		Reserved
0x4002_0000	0x4002_0FFF	APB1	Multi-Function Timer unit 0
0x4002_1000	0x4002_1FFF		Multi-Function Timer unit 1
0x4002_2000	0x4002_2FFF		Multi-Function Timer unit 2
0x4002_3000	0x4002_3FFF		Reserved
0x4002_4000	0x4002_4FFF		PPG
0x4002_5000	0x4002_5FFF		Base timer
0x4002_6000	0x4002_6FFF		Quadrature position/revolution counter
0x4002_7000	0x4002_7FFF		A/D converter
0x4002_8000	0x4002_DFFF		Reserved
0x4002_E000	0x4002_EFFF		Internal CR trimming
0x4002_F000	0x4002_FFFF		Reserved
0x4003_0000	0x4003_0FFF	APB2	External interrupt controller
0x4003_1000	0x4003_1FFF		Interrupt request batch-read function
0x4003_2000	0x4003_2FFF		Reserved
0x4003_3000	0x4003_3FFF		D/A converter
0x4003_4000	0x4003_4FFF		Reserved
0x4003_5000	0x4003_57FF		Low voltage detector
0x4003_5800	0x4003_5FFF		Deep standby mode Controller
0x4003_6000	0x4003_6FFF		Reserved
0x4003_7000	0x4003_7FFF		CAN prescaler
0x4003_8000	0x4003_8FFF		Multi-function serial interface
0x4003_9000	0x4003_9FFF		CRC
0x4003_A000	0x4003_AFFF		Watch counter
0x4003_B000	0x4003_BFFF		RTC/port control
0x4003_C000	0x4003_C0FF		Low-speed CR prescaler
0x4003_C100	0x4003_C7FF		Peripheral clock gating
0x4003_C800	0x4003_CFFF		Reserved
0x4003_D000	0x4003_DFFF		I ² S prescaler
0x4003_E000	0x4003_EFFF		Reserved
0x4003_F000	0x4003_FFFF		External memory interface

List of Pin Behavior by Mode State

Pin Status Type	Function Group	Power-On Reset or Low-Voltage Detection State	INITX Input State	Device Internal Reset State	Run mode or Sleep mode State	Timer mode, RTC mode, or Stop mode State		Deep Standby RTC mode or Deep Standby Stop mode State		Return From Deep Standby Mode State
		Power Supply Unstable	Power Supply Stable		Power Supply Stable	Power Supply Stable		Power Supply Stable		Power Supply Stable
		-	INITX=0	INITX=1	INITX=1	INITX=1		INITX=1		INITX=1
		-	-	-	-	SPL=0	SPL=1	SPL=0	SPL=1	-
A	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	Main crystal oscillator input pin/ external main clock input selected	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input Enabled
B	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	GPIO selected, internal input fixed at 0	Hi-Z/internal input fixed at 0	GPIO selected
	External main clock input selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/internal input fixed at 0	Maintain previous state	Hi-Z/internal input fixed at 0	Maintain previous State
	Main crystal oscillator output pin	Hi-Z/ internal input fixed at 0/ or input enable	Hi-Z/ internal input fixed at 0	Hi-Z/ internal input fixed at 0	Maintain previous state while oscillator active/ When oscillation stops*1, it will be Hi-Z/ Internal input fixed at 0					
C	INITX input pin	Pull-up/ input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled	Pull-up/ Input enabled
D	Mode input pin	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled
E	Mode input pin	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled	Input enabled
	GPIO selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z/ input enabled	GPIO selected	Hi-Z/ input enabled	GPIO selected

12.2 Recommended Operating Conditions

Parameter		Symbol	Conditions	Value		Unit	Remarks
				Min	Max		
Power supply voltage		V_{CC}	-	2.7 *3	5.5	V	
Power supply voltage (VBAT)		V_{BAT}	-	1.65	5.5	V	
Analog power supply voltage		AV_{CC}	-	2.7	5.5	V	$AV_{CC} = V_{CC}$
Analog reference voltage		AVRH	-	*2	AV_{CC}	V	
		AVRL	-	AV_{SS}	AV_{SS}	V	
Operating temperature	Junction temperature	T_J	-	- 40	+ 125	°C	
	Ambient temperature	T_A	-	-40	*1	°C	

*1: The maximum temperature of the ambient temperature (T_A) can guarantee a range that does not exceed the junction temperature (T_J).

The calculation formula of the ambient temperature (T_A) is:

$$T_A (\text{Max}) = T_J (\text{Max}) - P_d (\text{Max}) \times \theta_{JA}$$

P_d : Power dissipation (W)

θ_{JA} : Package thermal resistance (°C/W)

$$P_d (\text{Max}) = V_{CC} \times I_{CC} (\text{Max}) + \sum (I_{OL} \times V_{OL}) + \sum ((V_{CC} - V_{OH}) \times (-I_{OH}))$$

I_{OL} : L level output current

I_{OH} : H level output current

V_{OL} : L level output voltage

V_{OH} : H level output voltage

*2: The minimum value of analog reference voltage depends on the value of compare clock cycle (t_{CCK}). See 12.5. 12-bit A/D Converter for the details.

*3: For the voltage range between $V_{CC}(\text{min})$ and the low voltage detection reset (VDH), the MCU must be clocked from either the High-speed CR or the low-speed CR."

Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
L level output voltage	V _{OL}	4 mA type	V _{CC} ≥ 4.5 V, I _{OL} = 4 mA	V _{SS}	-	0.4	V	
			V _{CC} < 4.5 V, I _{OL} = 2 mA					
		8 mA type	V _{CC} ≥ 4.5 V, I _{OL} = 8 mA	V _{SS}	-	0.4	V	
			V _{CC} < 4.5 V, I _{OL} = 4 mA					
		10 mA type	V _{CC} ≥ 4.5 V, I _{OL} = 10 mA	V _{SS}	-	0.4	V	
			V _{CC} < 4.5 V, I _{OL} = 8 mA					
		12 mA type	V _{CC} ≥ 4.5 V, I _{OL} = 12 mA	V _{SS}	-	0.4	V	
			V _{CC} < 4.5 V, I _{OL} = 8 mA					
		The pin doubled as I ² C Fm+	V _{CC} ≥ 4.5 V, I _{OL} = 4 mA	V _{SS}	-	0.4	V	At GPIO
			V _{CC} < 4.5 V, I _{OL} = 3 mA					At I ² C Fm+
			V _{CC} ≤ 4.5 V, I _{OL} = 20 mA					
Input leak current	I _{IL}	-	-	- 5	-	+ 5	μA	
Pull-up resistor value	R _{PU}	Pull-up pin	V _{CC} ≥ 4.5 V	25	50	100	kΩ	
			V _{CC} < 4.5 V	30	80	200		
Input capacitance	C _{IN}	Other than V _{CC} , V _{BAT} , V _{SS} , AV _{CC} , AV _{SS} , AV _{RH}	-	-	5	15	pF	

12.4.8 Power-On Reset Timing

(V_{SS} = 0V)

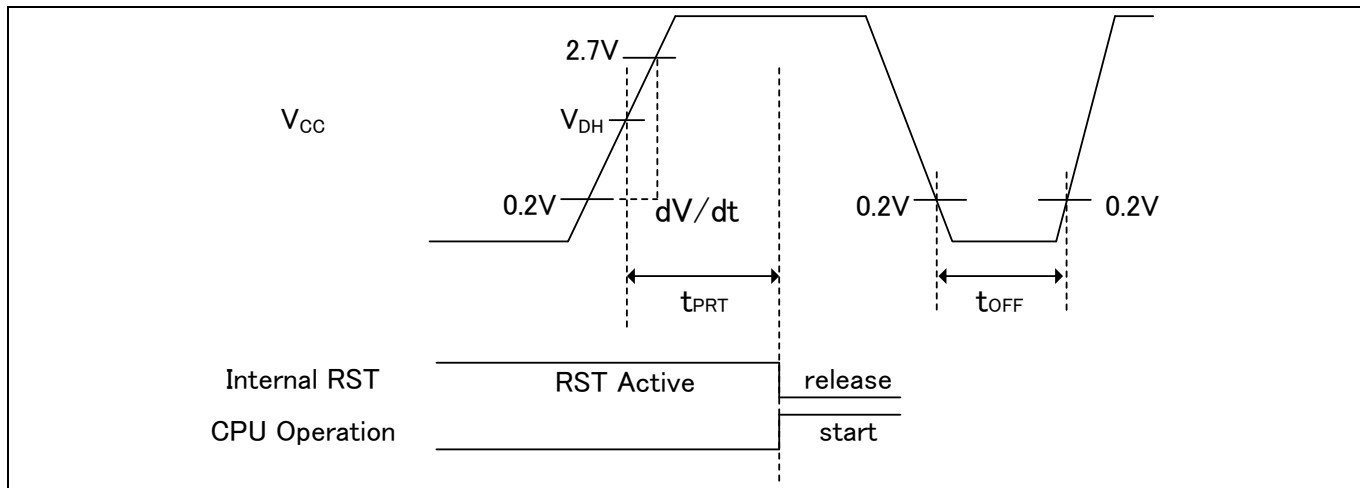
Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply shut down time	t _{OFF}	VCC	-	1	-	-	ms	*1
Power ramp rate	dV/dt		V _{CC} : 0.2V to 2.70V	0.6	-	1000	mV/μs	*2
Time until releasing Power-on reset	t _{PRT}		-	0.33	-	0.60	ms	

*1: V_{CC} must be held below 0.2V for a minimum period of t_{OFF}. Improper initialization may occur if this condition is not met.

*2: This dV/dt characteristic is applied at the power-on of cold start (t_{OFF}>1ms).

Note:

- If t_{OFF} cannot be satisfied designs must assert external reset(INITX) at power-up and at any brownout event per 12. 4. 7.



Glossary

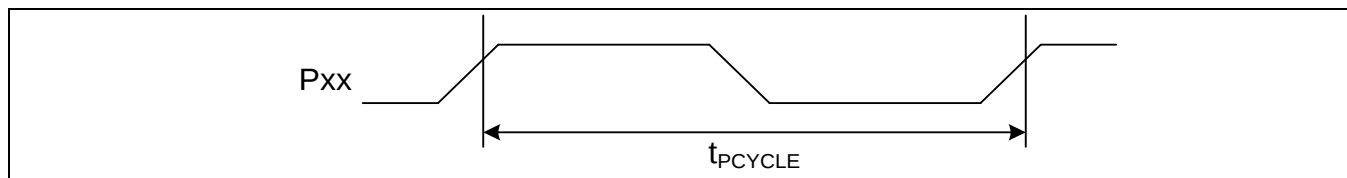
- V_{DH}: detection voltage of Low Voltage detection reset. See “12.7. Low-Voltage Detection Characteristics”.

12.4.9 GPIO Output Characteristics

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Typ		
Output frequency	t _{PCYCLE}	Pxx*	V _{CC} ≥ 4.5 V	-	50	MHz	
			V _{CC} < 4.5 V	-	32	MHz	

*: GPIO is a target.



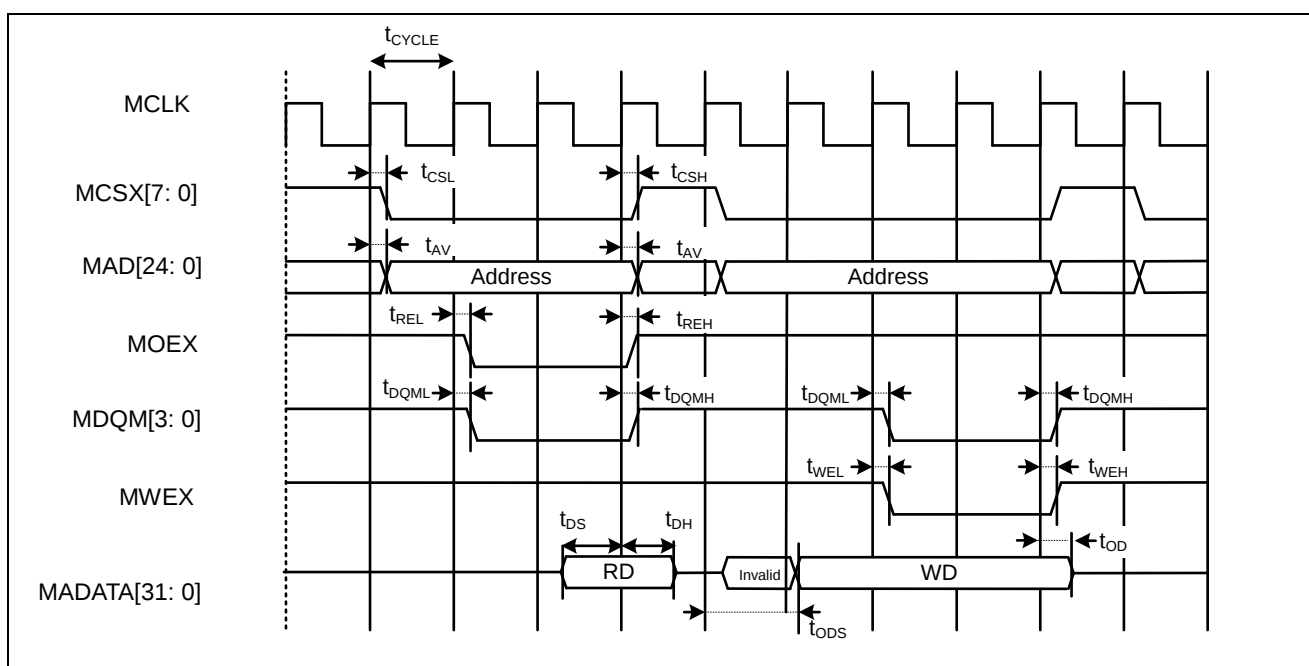
Separate Bus Access Synchronous SRAM Mode

($V_{CC} = 2.7V$ to $5.5V$, $V_{SS} = 0V$)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Address delay time	t_{AV}	MCLK, MAD[24: 0]	-	1	9	ns	
MCSX delay time	t_{CSL}	MCLK, MCSX[7: 0]	-	1	9	ns	
	t_{CSH}		-	1	9	ns	
MOEX delay time	t_{REL}	MCLK, MOEX	-	1	9	ns	
	t_{REH}		-	1	9	ns	
Data set up → MCLK ↑ time	t_{DS}	MCLK, MADATA[31: 0]	-	19	-	ns	
MCLK ↑ → Data hold time	t_{DH}	MCLK, MADATA[31: 0]	-	0	-	ns	
MWEX delay time	t_{WEL}	MCLK, MWEX	-	1	9	ns	
	t_{WEH}		-	1	9	ns	
MDQM[1: 0] delay time	t_{DQML}	MCLK, MDQM[3: 0]	-	1	9	ns	
	t_{DQMH}		-	1	9	ns	
MCLK ↑ → Data output time	t_{ODS}	MCLK, MADATA[31: 0]	-	MCLK+1	MCLK+18	ns	
MCLK ↑ → Data hold time	t_{OD}	MCLK, MADATA[31: 0]	-	1	18	ns	

Note:

- When the external load capacitance $C_L = 30$ pF



High-Speed Synchronous Serial (SPI = 0, SCINV = 1)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Pin Name	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t _{SCYC}	SCKx	Internal shift clock operation	4t _{CYCP}	-	4t _{CYCP}	-	ns
SCK↑→SOT delay time	t _{SHOVI}	SCKx, SOTx		- 10	+ 10	- 10	+ 10	ns
SIN→SCK↓ setup time	t _{IVSLI}	SCKx, SINx		14	-	12.5	-	ns
				12.5*				
SCK↓→SIN hold time	t _{SLIXI}	SCKx, SINx	External shift clock operation	5	-	5	-	ns
Serial clock L pulse width	t _{SLSH}	SCKx		2t _{CYCP} - 5	-	2t _{CYCP} - 5	-	ns
Serial clock H pulse width	t _{SHSL}	SCKx		t _{CYCP} + 10	-	t _{CYCP} + 10	-	ns
SCK↑→SOT delay time	t _{SHOVE}	SCKx, SOTx		-	15	-	15	ns
SIN→SCK↓ setup time	t _{IVSLE}	SCKx, SINx		5	-	5	-	ns
SCK↓→SIN hold time	t _{SLIXE}	SCKx, SINx		5	-	5	-	ns
SCK fall time	t _F	SCKx		-	5	-	5	ns
SCK rise time	t _R	SCKx		-	5	-	5	ns

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- These characteristics only guarantee the following pins:
 No chip select: SIN4_0, SOT4_0, SCK4_0
 Chip select: SIN6_0, SOT6_0, SCK6_0, SCS60_0, SCS61_0, SCS62_0, SCS63_0
- When the external load capacitance C_L = 30 pF. (For *, when C_L = 10 pF)

12.4.13 External Input Timing

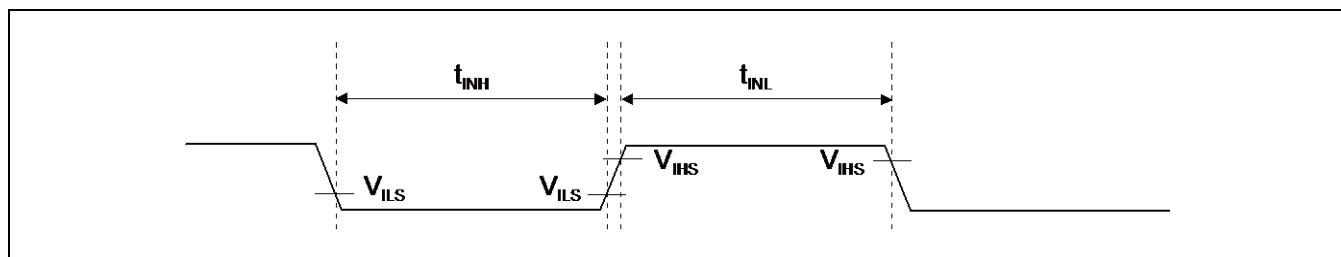
($V_{CC} = 2.7V$ to $5.5V$, $V_{SS} = 0V$)

Parameter	Symbol	Pin Name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{INH} , t_{INL}	ADTGx	-	$2t_{CYCP}^{*1}$	-	ns	A/D converter trigger input
		FRCKx					Free-run timer input clock
		ICxx					Input capture
		DTTixX	-	$2t_{CYCP}^{*1}$	-	ns	Waveform generator
		INT00 to INT31, NMIX	-	$2t_{CYCP} + 100^{*1}$	-	ns	External interrupt, NMI
				500^{*2}	-	ns	
		WKUPx	-	500^{*3}	-	ns	Deep standby wake up

*1: t_{CYCP} indicates the APB bus clock cycle time except stop when in Stop mode, in Timer mode. For more information about the APB bus number to which the A/D converter, multi-function timer, and external interrupt are connected, see 8. Block Diagram in this data sheet.

*2: When in Stop mode, in Timer mode

*3: When in Deep Standby RTC mode, in Deep Standby Stop mode



12.4.15 I²C Timing

Standard-mode, Fast-mode

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Conditions	Standard-mode		Fast-mode		Unit	Remarks
			Min	Max	Min	Max		
SCL clock frequency	f _{SCL}	C _L = 30 pF, R = (V _p /I _{OL})* ¹	0	100	0	400	kHz	
(Repeated) START condition hold time SDA ↓ → SCL ↓	t _{HDSTA}		4.0	-	0.6	-	μs	
SCL clock L width	t _{LOW}		4.7	-	1.3	-	μs	
SCL clock H width	t _{HIGH}		4.0	-	0.6	-	μs	
(Repeated) START condition setup time SCL ↑ → SDA ↓	t _{SUSTA}		4.7	-	0.6	-	μs	
Data hold time SCL ↓ → SDA ↓ ↑	t _{HDDAT}		0	3.45* ²	0	0.9* ³	μs	
Data setup time SDA ↓ ↑ → SCL ↑	t _{SUDAT}		250	-	100	-	ns	
Stop condition setup time SCL ↑ → SDA ↑	t _{SUSTO}		4.0	-	0.6	-	μs	
Bus free time between "Stop condition" and "START condition"	t _{BUF}		4.7	-	1.3	-	μs	
Noise filter	t _{SP}	2 MHz ≤ t _{CYCP} < 40 MHz	2 t _{CYCP} * ⁴	-	2 t _{CYCP} * ⁴	-	ns	*5
		40 MHz ≤ t _{CYCP} < 60 MHz	4 t _{CYCP} * ⁴	-	4 t _{CYCP} * ⁴	-	ns	
		60 MHz ≤ t _{CYCP} < 80 MHz	6 t _{CYCP} * ⁴	-	6 t _{CYCP} * ⁴	-	ns	
		80 MHz ≤ t _{CYCP} ≤ 100 MHz	8 t _{CYCP} * ⁴	-	8 t _{CYCP} * ⁴	-	ns	

*1: R and C_L represent the pull-up resistance and load capacitance of the SCL and SDA lines, respectively. V_p indicates the power supply voltage of the pull-up resistance and I_{OL} indicates V_{OL} guaranteed current.

*2: The maximum t_{HDDT} must not extend beyond the low period (t_{LOW}) of the device's SCL signal.

*3: Fast-mode I²C bus device can be used on a Standard-mode I²C bus system as long as the device satisfies the requirement of "t_{SUDAT} ≥ 250 ns."

*4: t_{CYCP} is the APB bus clock cycle time. For more information about the APB bus number to which the I²C is connected, see "8.Block Diagram" in this data sheet.

When using Standard-mode, the peripheral bus clock must be set more than 2 MHz.

When using Fast-mode, the peripheral bus clock must be set more than 8 MHz.

*5: The noise filter time can be changed by register settings. Change the number of the noise filter steps according to the APB bus clock frequency.

High-Speed Mode

■ Clock CLK (All values are referred to V_{IH} and V_{IL})

($V_{CC} = 2.7V$ to $3.6V$, $V_{SS} = 0V$)

Parameter	Symbol	Pin Name	Conditions	Value		Remarks
				Min	Max	
Clock frequency Data Transfer Mode	f_{PP}	S_CLK	$C_{CARD} \leq 10$ pF (1 card)	0	50	MHz
Clock low time	t_{WL}	S_CLK		7	-	ns
Clock high time	t_{WH}	S_CLK		7	-	ns
Clock rise time	t_{TLH}	S_CLK		-	3	ns
Clock fall time	t_{THL}	S_CLK		-	3	ns

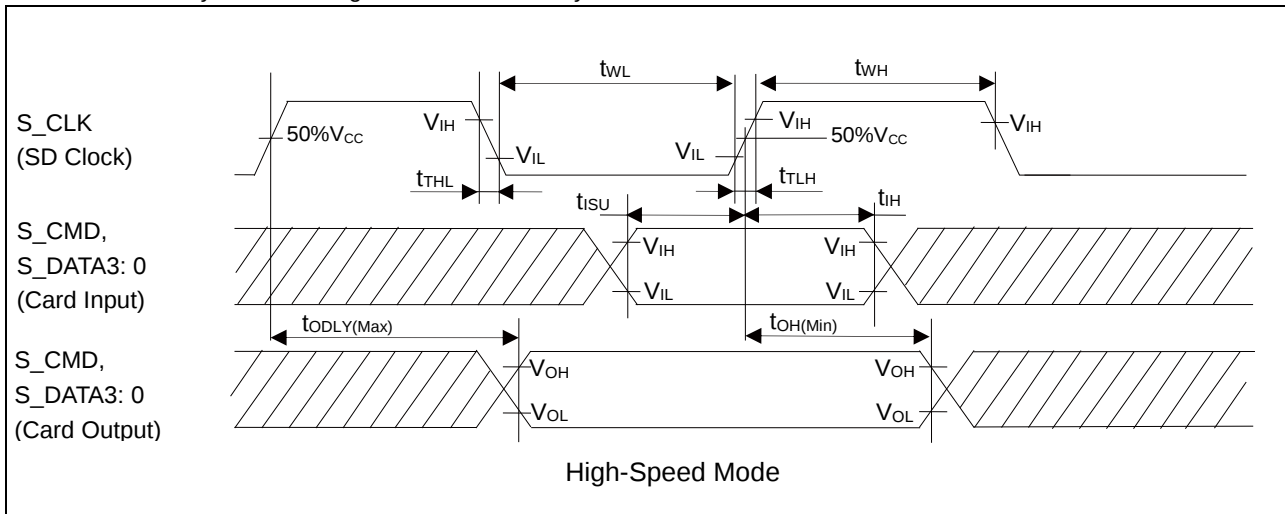
■ Card Inputs CMD, DAT (referenced to Clock CLK)

Parameter	Symbol	Pin Name	Conditions	Value		Remarks
				Min	Max	
Input set-up time	t_{ISU}	S_CMD, S_DATA3: 0	$C_{CARD} \leq 10$ pF (1 card)	6	-	ns
Input hold time	t_{IH}	S_CMD, S_DATA3: 0		2	-	ns

■ Card Outputs CMD, DAT (referenced to Clock CLK)

Parameter	Symbol	Pin Name	Conditions	Value		Remarks
				Min	Max	
Output delay time during data transfer mode	t_{ODLY}	S_CMD, S_DATA3: 0	$C_L \leq 40$ pF (1 card)	0	14	ns
Output hold time	t_{OH}	S_CMD, S_DATA3: 0	$C_L \geq 15$ pF (1 card)	2.5	-	ns
Total system capacitance for each line*	C_L	-	1 card	-	40	pF

*: In order to satisfy severe timing, host shall drive only one card.



Notes:

- The Card Input corresponds to the Host Output and the Card Output corresponds to the Host Input because this model is the Host.
- For more information about clock frequency (f_{PP}), see Chapter 15: SD card Interface in FM4 Family Peripheral Manual Main Part (002-04856).